

Switch-mode Power Rectifiers MBR5H100MFS, NRVB5H100MFS

These state-of-the-art devices have the following features:

Features

- Low Power Loss / High Efficiency
- New Package Provides Capability of Inspection and Probe After Board Mounting
- Guardring for Stress Protection
- Low Forward Voltage Drop
- 175°C Operating Junction Temperature
- NRVB Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These are Pb-Free Devices

Mechanical Characteristics:

- Case: Epoxy, Molded
- Epoxy Meets Flammability Rating UL 94-0 @ 0.125 in.
- Lead Finish: 100% Matte Sn (Tin)
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Device Meets MSL 1 Requirements

MAXIMUM RATINGS

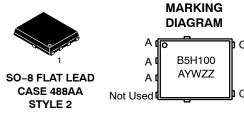
| Rating | Symbol | Value | Unit |
|---|--|-------------|------|
| Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage | V _{RRM} V _{RWM} V _R | 100 | V |
| Average Rectified Forward Current (Rated V _R , T _C = 150°C) | I _{F(AV)} | 5 | Α |
| Peak Repetitive Forward Current, (Rated V _R , Square Wave, 20 kHz, T _C = 150°C) | I _{FRM} | 10 | А |
| Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz) | I _{FSM} | 200 | A |
| Storage Temperature Range | T _{stg} | -65 to +175 | °C |
| Operating Junction Temperature | TJ | -55 to +175 | °C |
| Voltage Rate of Change (Rated V _R) | dv/dt | 10,000 | V/μs |
| Unclamped Inductive Switching Energy (10 mH Inductor, Non-repetitive) | E _{AS} | 100 | mJ |
| ESD Rating (Human Body Model) | | 3B | |
| ESD Rating (Machine Model) | | С | |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1

SCHOTTKY BARRIER RECTIFIERS 5 AMPERES 100 VOLTS





B5H100 = Specific Device Code A = Assembly Location

Y = Year
W = Work Week
ZZ = Lot Traceability

ORDERING INFORMATION

| Device | Package | Shipping [†] |
|-----------------|----------------------|-----------------------|
| MBR5H100MFST1G | SO-8 FL (Pb-Free) | 1500 / Tape & Reel |
| NRVB5H100MFST3G | SO-8 FL (Pb-Free) | 5000 / Tape & Reel |

DISCONTINUED (Note 1)

| MBR5H100MFST3G | SO-8 FL (Pb-Free) | 5000 / Tape & Reel |
|-----------------|----------------------|-----------------------|
| NRVB5H100MFST1G | SO-8 FL (Pb-Free) | 1500 / Tape & Reel |

- †For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.
- DISCONTINUED: These devices are not recommended for new design. Please contact your onsemi representative for information. The most current information on these devices may be available on www.onsemi.com.

MBR5H100MFS, NRVB5H100MFS

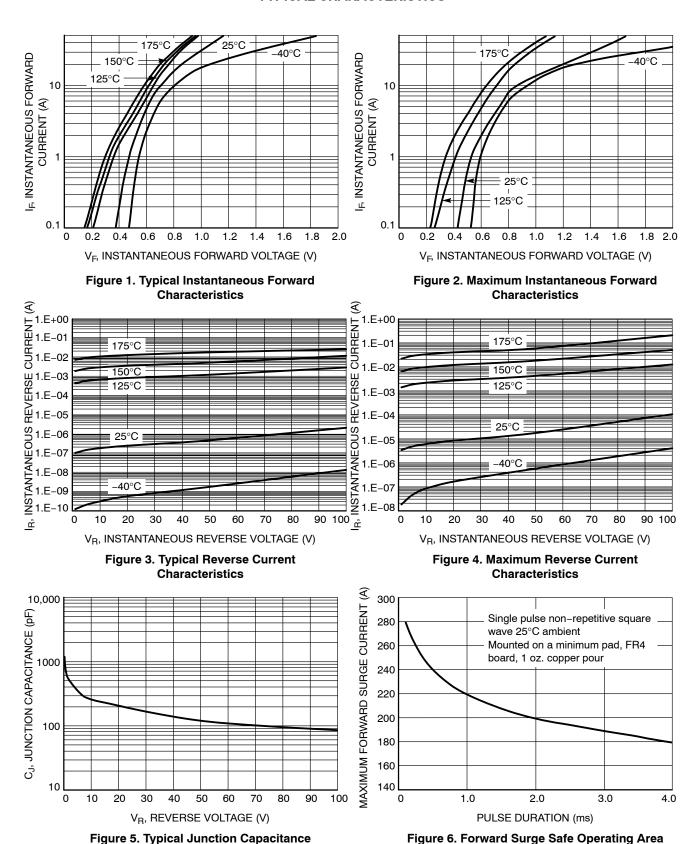
THERMAL CHARACTERISTICS

| Characteristic | Symbol | Тур | Max | Unit |
|---|----------------|-------------|-------------|------|
| Thermal Resistance, Junction-to-Case, Steady State (Assumes 600 mm ² 1 oz. copper bond pad, on a FR4 board) | $R_{	heta JC}$ | - | 2.4 | °C/W |
| ELECTRICAL CHARACTERISTICS | • | | | |
| Instantaneous Forward Voltage (Note 1) (i _F = 5 Amps, T _J = 125°C) (i _F = 5 Amps, T _J = 25°C) | VF | 0.56 0.6 | 0.6 0.73 | V |
| Instantaneous Reverse Current (Note 1) (Rated dc Voltage, T _J = 125°C) (Rated dc Voltage, T _J = 25°C) | İR | 3 0.003 | 13 0.1 | mA |

^{1.} Pulse Test: Pulse Width = 300 μ s, Duty Cycle \leq 2.0%.

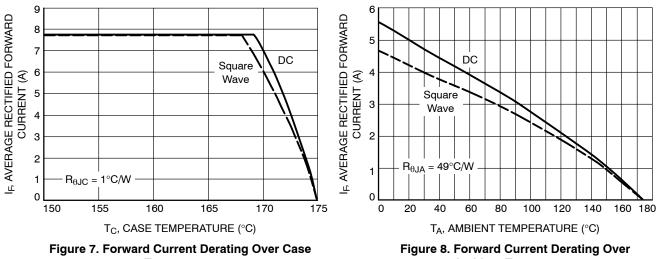
MBR5H100MFS, NRVB5H100MFS

TYPICAL CHARACTERISTICS



MBR5H100MFS, NRVB5H100MFS

TYPICAL CHARACTERISTICS



Temperature



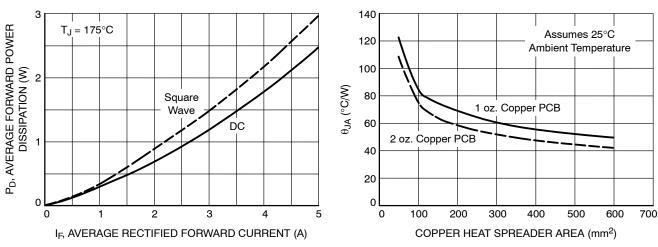


Figure 9. Maximum Forward Power Dissipation

Figure 10. Steady State Junction to Ambient **Thermal Resistance**

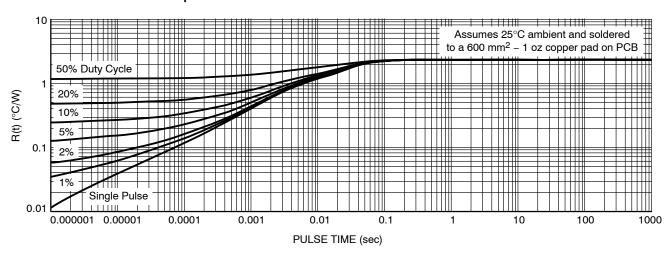


Figure 11. Transient Thermal Response, Junction to Case





0.10

SIDE VIEW

DFN5 5x6, 1.27P (SO-8FL) CASE 488AA ISSUE N

DATE 25 JUN 2018

NOTES:

- DIMENSIONING AND TOLERANCING PER
- ASME Y14.5M, 1994. CONTROLLING DIMENSION: MILLIMETER. DIMENSION D1 AND E1 DO NOT INCLUDE
- MOLD FLASH PROTRUSIONS OR GATE BURRS

| | MILLIMETERS | | | |
|-----|-------------|-------|------|--|
| DIM | MIN | NOM | MAX | |
| Α | 0.90 | 1.00 | 1.10 | |
| A1 | 0.00 | | 0.05 | |
| b | 0.33 | 0.41 | 0.51 | |
| С | 0.23 | 0.28 | 0.33 | |
| D | 5.00 | 5.15 | 5.30 | |
| D1 | 4.70 | 4.90 | 5.10 | |
| D2 | 3.80 | 4.00 | 4.20 | |
| E | 6.00 | 6.15 | 6.30 | |
| E1 | 5.70 | 5.90 | 6.10 | |
| E2 | 3.45 | 3.65 | 3.85 | |
| е | 1.27 BSC | | | |
| G | 0.51 | 0.575 | 0.71 | |
| K | 1.20 | 1.35 | 1.50 | |
| L | 0.51 | 0.575 | 0.71 | |
| L1 | 0.125 REF | | | |
| M | 3.00 | 3.40 | 3.80 | |
| θ | 0 ° | | 12 ° | |

GENERIC MARKING DIAGRAM*



XXXXXX = Specific Device Code

= Lot Traceability

= Assembly Location Α

Υ = Year W = Work Week

ZZ

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ", may or may not be present. Some products may not follow the Generic Marking.





DETAIL A

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

Electronic versions are uncontrolled except when accessed directly from the Document Repository. **DOCUMENT NUMBER:** 98AON14036D Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red. **DESCRIPTION:** DFN5 5x6, 1.27P (SO-8FL) **PAGE 1 OF 1**

onsemi and ONSEMI are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves the right to make changes without further notice to any products herein. onsemi makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.

onsemi, Onsemi, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. Onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA class 3 medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase

ADDITIONAL INFORMATION

TECHNICAL PUBLICATIONS:

 $\textbf{Technical Library:} \ \underline{www.onsemi.com/design/resources/technical-documentation}$

onsemi Website: www.onsemi.com

ONLINE SUPPORT: www.onsemi.com/support

For additional information, please contact your local Sales Representative at

www.onsemi.com/support/sales